



Product Change Notification

Change Notification #: 116495 - 00
Change Title: Intel® Data Center Blocks for Cloud
MCB2224BPHY1, MCB2208WFHY2,
MCB2224BPAF3, MCB2208WFAF4,
MCB2208WFAF5, MCB2208WFAF6,
PCN 116495-00, Product Design, Order Code,
Replacing select end of life Intel SSD
components
Date of Publication: September 21, 2018

Key Characteristics of the Change:

Product Design, Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	October 22, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel Corporation is implementing the following changes to the Intel® Data Center Blocks for Cloud:

1. Replacing end of life Intel SSDs with new models for MCB2224BPHY1, MCB2208WFHY2, MCB2224BPAF3, MCB2208WFAF4, MCB2208WFAF5 and MCB2208WFAF6:
 - a. Intel® SSD DC S4500 with Intel® SSD D3 S4510
 - b. Intel® SSD DC S4600 with Intel® SSD D3 S4610
 - c. Intel® SSD DC P4500 with Intel® SSD DC P4510
 - d. Intel® SSD DC P4600 with Intel® SSD DC P4610
 - e. Intel® SSD DC P3100 with Intel® SSD DC P4101
2. Adding Intel® RAID Expander RES3TV360 to the MCB2208WFHY2 to provide SCSI Enclosure Services support.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the changes and determine the impact on their applications.

The date of “Customer Must be Ready to Receive Post-Conversion Material” is the projected date that customers must be prepared to start receiving the Post-Converted Material. After this date, the Pre-Conversion SKUs will be discontinued and no longer guaranteed. They may be available only on a first come first serve basis, while supply lasts.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Post Change MM#
MCB2224BPFAF3	961082	9999P4
MCB2208WFAF6	963647	9999P3
MCB2208WFAF5	963648	9999P8
MCB2208WFAF4	963649	9999P9
MCB2224BPHY1	964007	9999PD
MCB2208WFHY2	964008	9999PA

PCN Revision History:

Date of Revision:
September 21, 2018

Revision Number:
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Reason:
Originally Published PCN



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116495 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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